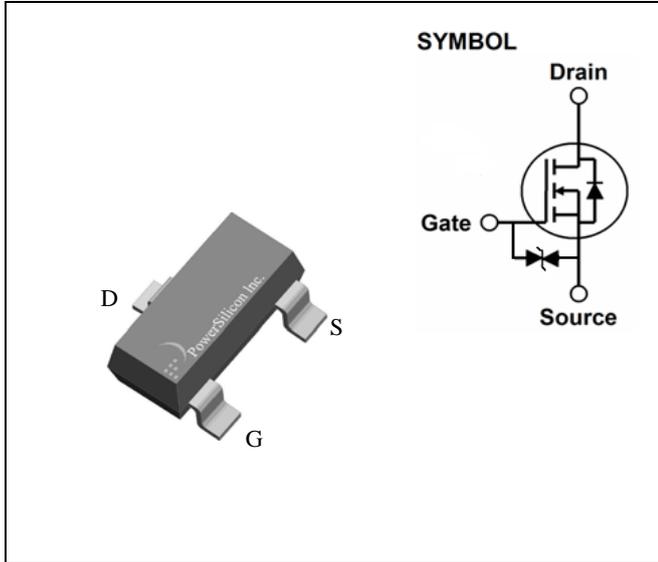


N-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR



FEATURES

- N-channel Enhancement Mode Field Effect Transistor, Designed For High Speed Pulse Amplifier And Drive Application, Which Is Manufactured By The N-Channel DMOS Process.
- ESD MIL-STD 883C, ±2.5KV Contact Discharge Compliant Protection

MECHANICAL DATA

- Available in SOT-23 Package
- Solderability : MIL-STD-202, Method 208
- Full RoHS Compliance

ORDERING INFORMATION

PART NUMBER	PACKAGE	SHIPPING	MARKING CODE
2N7002K□-T3	SOT-23	Tape Reel	7002K

Notes:

1. □: none is for Lead Free package;
"G" is for Halogen Free package.

THERMAL DATA

PARAMETER	SYMBOL	VALUES	UNIT
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	357	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	90	°C/W

Notes:

2. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design. The value of $R_{\theta JA}$ is measured with device mounted on 1 in² FR-4 board with 2 oz copper.

ABSOLUTE MAXIMUM RATINGS
 $T_A = 25^\circ\text{C}$, unless otherwise noted. ^(Note 3)

PARAMETER	SYMBOL	VALUE	UNIT
Drain-Source Voltage	V_{DSS}	60	V
Gate-Source Voltage	V_{GSS}	± 20	V
Drain Current (Pulsed) ^(Note 4)	I_{DM}	800	mA
Drain Current (Continuous)	I_D	300	mA
Maximum Power Dissipation	P_D	350	mW
Operating Junction Temperature Range	T_J	-55 to +150	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-55 to +150	$^\circ\text{C}$

Notes:

3. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
4. Pulse width limited by maximum junction temperature.

ELECTRICAL CHARACTERISTICS
 $T_C = 25^\circ\text{C}$, unless otherwise noted.

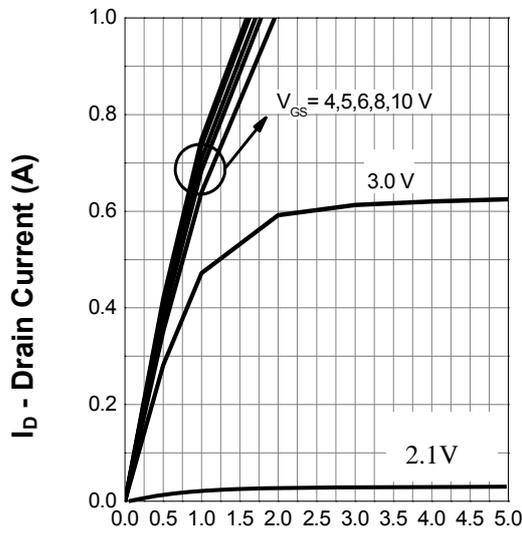
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0V, I_D = 10\mu A$	60			V
Drain-Source Leakage Current	I_{DSS}	$V_{GS} = 0V, V_{DS} = 60V, T_J = 25^\circ\text{C}$			1	μA
Gate- Source Leakage Current	$\pm I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 20V$			± 10	μA
ON CHARACTERISTICS ^(Note 5)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.0	1.7	2.5	V
Static Drain-Source On Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 300mA$		2.0	3.0	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{iss}	$V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$			50	pF
Output Capacitance	C_{oss}				25	
Reverse Transfer Capacitance	C_{rss}				5.0	
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 30V, I_D = 200mA,$ $R_L = 150\Omega, V_{GEN} = 10V$ $R_{GEN} = 25\Omega$		6		nS
Turn-On Rise Time	t_r			5		
Turn-Off Delay Time	$t_{d(off)}$			25		
Turn-Off Fall Time	t_f			15		
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
Drain-source Diode Forward Voltage	V_{SD}	$V_{GS} = 0V, I_S = 300mA$		0.85	1.5	V
Transfer Admittance	$ Y_{fs} $	$I_D = 200mA, V_{DS} = 15V$	80			mS

Notes:

 5. Pulse test : Pulse width $\leq 300\mu S$, Duty cycle $\leq 2\%$

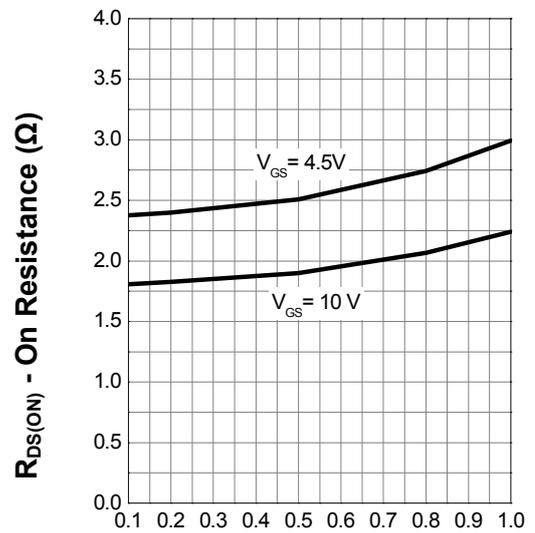
TYPICAL PERFORMANCE CHARACTERISTICS

Output Characteristics



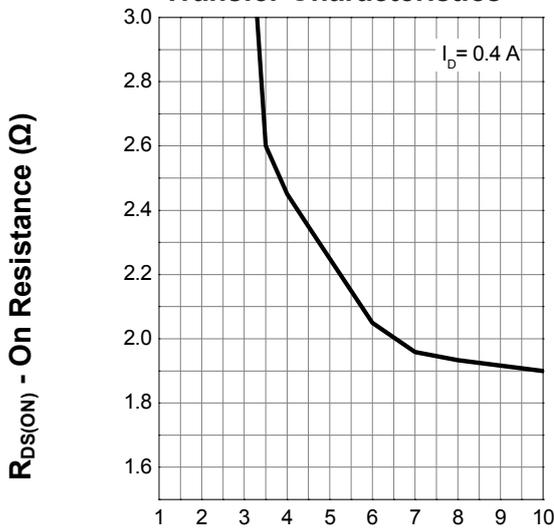
V_{DS} - Drain-Source Voltage (V)

Drain-Source On Resistance



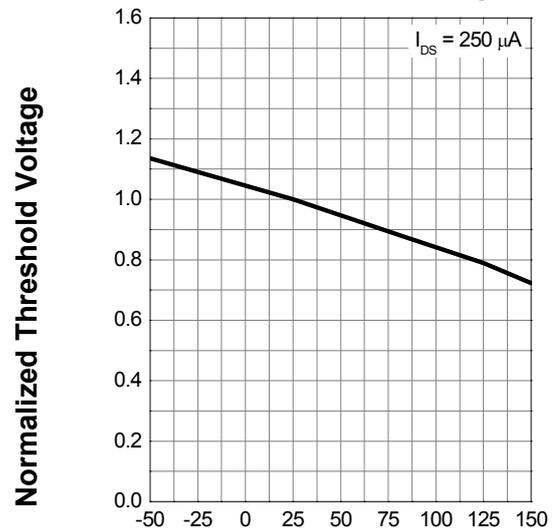
I_D - Drain Current (A)

Transfer Characteristics



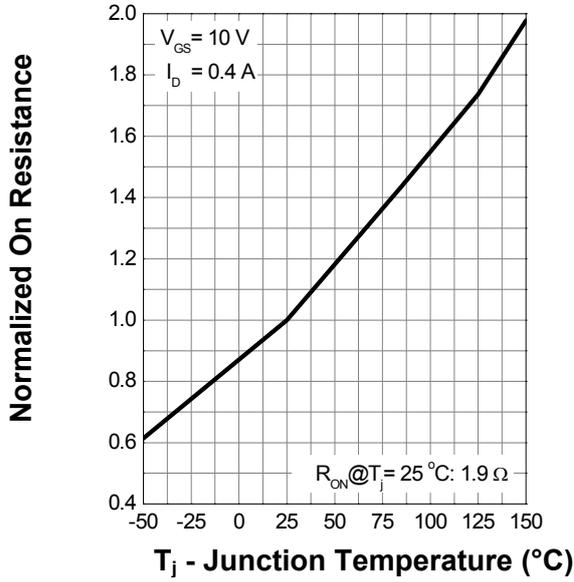
V_{GS} - Gate-Source Voltage (V)

Gate Threshold Voltage

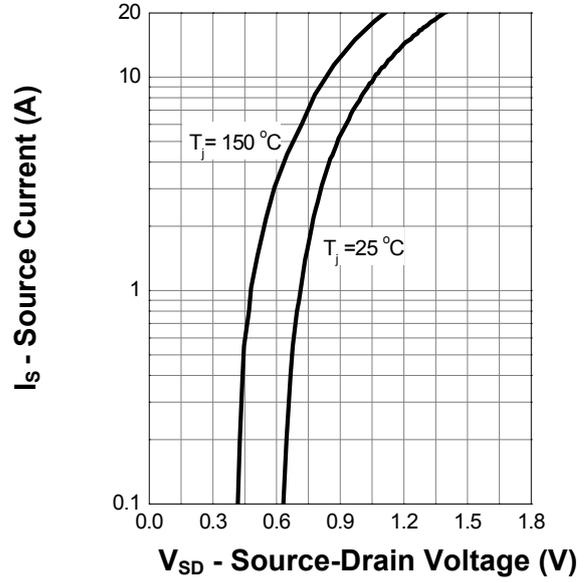


T_j - Junction Temperature ($^{\circ}C$)

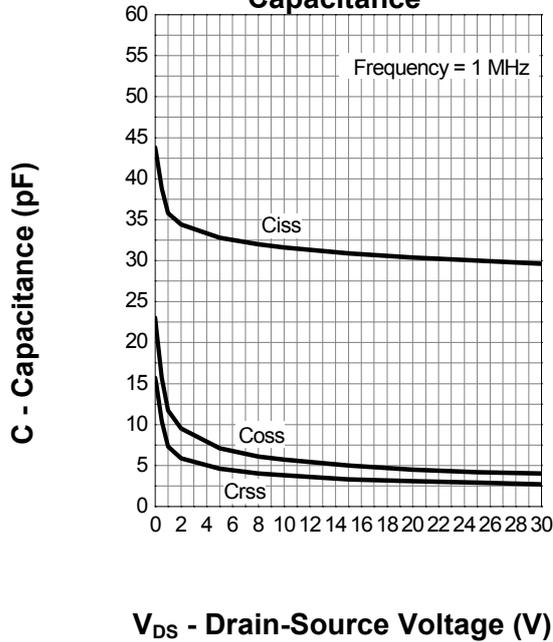
Drain-Source On Resistance



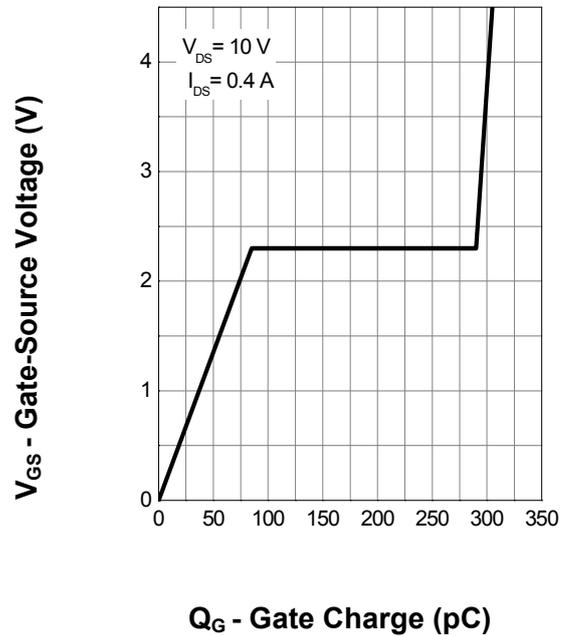
Source-Drain Diode Forward



Capacitance

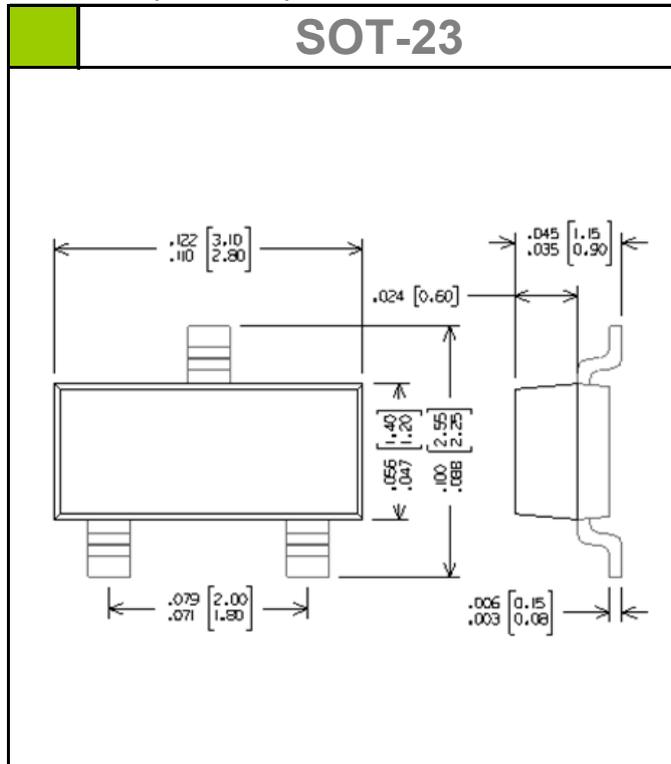


Gate Charge



PHYSICAL DIMENSION

Unit : Inch (Millimeter)



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